TFAWS Active Thermal Paper Session



Digital Twin of an Industrial Condenser for Lunar In-Situ Resource Utilization

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Digital Engineering | Transformation

Digital Engineering (DE): An integrated digital approach that uses authoritative sources of systems' data and models as a continuum across disciplines to support life cycle activities from concept through disposal.





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TFAWS 2023 - August 21-25, 2023

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Lunar In-Situ Resource Utilization (ISRU)

Lunar Carbothermal Reduction with Solid-Oxide Electrolysis





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Digital Twin







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Simulation Software



NX : CAD

- Import STEP files for relevant geometry
- Optimize geometry for simulation processing

STAR-CCM+ : CFD

- Mesh imported geometry from NX
- Conduct computational fluid dynamics simulations to validate part designs

Teamcenter : MBSE

- Thread subsystems
- Parameterize inputs/outputs to quickly update different environments





Overview: Condenser Modeling

Methanation Reactor

Condenser

Solid-Oxide H2O Electrolysis



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Condenser Modeling Overview





- Methane and water vapor enter the condenser
- Water vapor condensates and is led to electrolyzer
- The condenser consists of three main parts:
 - inner fluid (where liquid water is formed)
 - outer fluid (where coolant draws heat from process fluid)
 - solid shell (the structure containing and separating the inner and outer fluid)



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CAD of the Industrial Condenser



Used the functions in NX to optimize CAD drawing for better meshing operations and Parasolid generation



- Original CAD models solid regions, fluid volume extracted as separate parts for different physics
- Model is bisected along a symmetry plane to reduce computation





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Import to CFD





- The CAD is exported as a Parasolid file and then imported to STAR-CCM+
- The tolerance and grain size can be adjusted for better resolution
- The conformal imprinting of coincident entities allows more accurate iterations



Conformal Meshing cell to cell

arasolid Transmit Impo	rt Options		
Mark Feature Edges	Sharp CAD edges 🗸		
Sharp Edge Angle (deg)	30.0		
	Merge Parts by Name		
	Create One Part Surface per Part		
	Create Part Contacts from Coincident Entities		
	Create Shells		
Coincidence Tolerance	1.0E-6		
	Check Parts' Validity		
	Repair Invalid Bodies		
	Simplify Assembly Structure		
	Import Colors of Unnamed Entities		
Importer Preference	Import Settings	\sim	
Tessellation Density Very Fine		\sim	
	Show Detailed Tessellation Parameters		
mport Options			
Open Geometry Scen	e After Import		







Physics Continuum





- The initial heat transfer model was simple air flow at 22.25C in counter flow with cold water at 5C in steady state
- Models are chosen for accuracy to the situation while avoiding inefficiencies with unnecessary calculations
- · Models below are used to simulate heat transfer

. I	Enabled Models	Enabled Models	Enabled Models
	Coupled Energy	Coupled Energy <not by="" mod<="" other="" required="" td=""></not>	els> 🗹 Gradients
	🗹 Ideal Gas	Gradients	Coupled Solid Energy <pre><not by="" models="" other="" required=""></not></pre>
1	Coupled Species	Coupled Flow	Solution Interpolation <not by="" models="" other="" required=""></not>
	Gradients	Solution Interpolation <not by="" mod<="" other="" required="" th=""><th>ls> 🗹 Constant Density</th></not>	ls> 🗹 Constant Density
	Coupled Flow	🗹 Laminar	☑ Steady
	☑ Non-reacting	☑ Steady	☑ Solid
	Multi-Component Gas	Constant Density	☑ Three Dimensional
	Solution Interpolation Not required by other models>	☑ Liquid	
	🖂 Laminar	Three Dimensional	
	Steady		
	Three Dimensional		
	Physics models for Inner Fluid	Physics models for Outer Fluid	Physics models for Solid Shell





Physics Continuum





- A separate simulation that only includes the inner fluid part is used to model condensation. This is done to simplify and reduce computation requirements during model development until both simulations are combined.
- The condenser physics initializes in implicit unsteady state







Boundary Conditions



- Each fluid/solid part is assigned to its own region
- Each fluid region is split by patch to identify an inlet, outlet, wall, and symmetry plane
- Appropriate boundary conditions and interfaces are defined





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Boundary Conditions





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Boundary Conditions



- Boundaries for condensation and heat transfer models are identical where applicable
- The fluid film model requires a shell region
- The film region boundary conditions should reflect the parent region





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Meshing





- The automated mesher is used to generate mesh of volume
- The mesher uses the prism layer, surface remesher, and polyhedral volume mesher
- Thin mesher is used in the solid tubes
- The set base cell size allows easy manipulation of relative target & minimum sizes
- Lower value cell quality indicates more reliable calculations in the cell





Condenser Modeling Results





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